

128x64Dots Serial/Parallel LCD

ST7920 Chinese Fonts built in LCD controller/driver

Main Features

- I Operation Voltage Range:
 - Ø 4.5V to 5.5V
- I Support 8-bit, 4-bit and serial bus MPU interface
- 64 x 16-bit display RAM (DDRAM)
 - Ø Supports 16 words x 4 lines (Max)
 - Ø LCD display range 16 words x 2 lines
- 64 x 256-bit Graphic Display RAM (GDRAM)
- 2M-bits Character Generation ROM (CGROM): Support 8192 Chinese words (16x16 dot matrix)
- I 16K-bit half-width Character Generation ROM (HCGROM):
 - Supports 126 characters (16x8 dot matrix)
- I 32-common x 64-segment (2 lines of character) LCD drivers
- I Automatic power on reset (POR)
- I External reset pin (XRESET)
- I With the extension segment drivers, the display area can up to 16x2 lines
- Built-in RC oscillator:
 - Frequency is adjusted by an external resistor

- I Low power consumption design
 - Ø Normal mode (450uA Typ VDD=5V)
 - Ø Standby mode (30uA Max VDD=5V)
- I VLCD (V0 to V_{SS}): max 7V
- I Graphic and character mixed display mode
- Multiple instructions:
 - Ø Display Clear
 - Ø Return Home
 - Ø Display ON/OFF
 - Ø Cursor ON/OFF
 - Ø Display Character Blink
 - Ø Cursor Shift
 - Ø Display Shift
 - Ø Vertical Line Scroll
 - Ø Reverse Display (by line)
 - Ø Standby Mode
- Built-in voltage booster (2 times)

VOUT: max 7V

I 1/33 Duty (with ICON)

Function Description

ST7920 LCD controller/driver IC can display alphabets, numbers, Chinese fonts and self-defined characters. It supports 3 kinds of bus interface, namely 8-bit, 4-bit and serial. All functions, including display RAM, Character Generation ROM, LCD display drivers and control circuits are all in a one-chip solution. With a minimum system configuration, a Chinese character display system can be easily achieved.

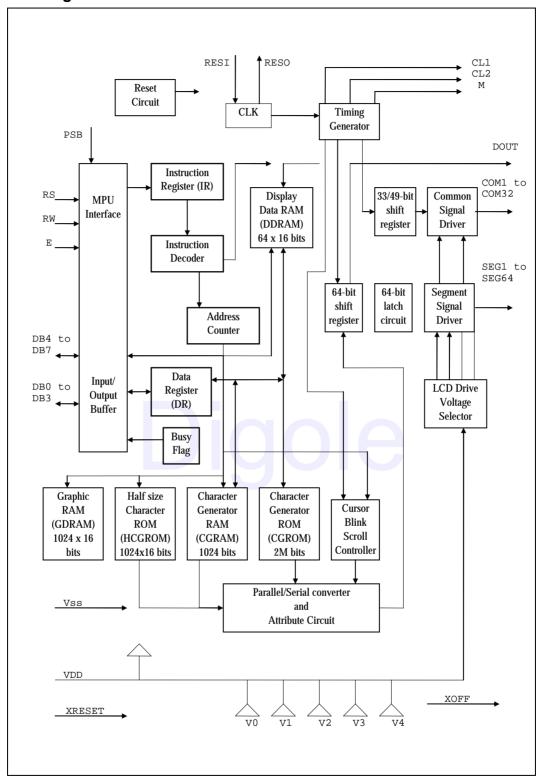
ST7920 includes character ROM with 8192 16x16 dots Chinese fonts and 126 16x8 dots half-width alphanumerical fonts. Besides, it supports 64x256 dots graphic display area for graphic display (GDRAM). Mix-mode display with both character and graphic data is possible. ST7920 has built-in CGRAM and provide 4 sets software programmable 16x16 fonts.

ST7920 has wide operating voltage range (2.7V to 5.5V). It also has low power consumption. So ST7920 is suitable for battery-powered portable device.

ST7920 LCD driver consists of 32-common and 64-segment. Company with the extension segment driver (ST7921) ST7920 can support up to 32-common x 256-segment display.

Part Number	Font Code
ST7920-0A	BIG-5 Code Set (Traditional Chinese)
ST7920-0B	GB Code Set (Simplified Chinese)
ST7920-0C	Chinese (Traditional/Simplified) & Japanese
ST7920-0F	Chinese (Traditional/Simplified), Japanese & Korean

System Block Diagram



Pin Description

Name	No.	I/O	Connects to	Function
RST	17	I	_	System reset input (low active).
				Interface selection:
PSB	15	I	_	0: serial mode;
				1: 8/4-bit parallel bus mode.
				Parallel Mode: Register select.
				0: Select instruction register (write)
				or busy flag, address counter (read);
				1: Select data register (write/read).
RS(CS*)	4		MPU	Serial mode: Chip select.
RS(CS)	4		IVIFU	1: chip enabled;
				0: chip disabled.
				When chip is disabled, SID and SCLK
				should be set as "H" or "L". Transcient
				of SID and SCLK is not allowed.
				Parallel Mode: Read/Write control.
DW/(CID*)	_	١.	MDU	0: Write;
RW(SID*)	5	I	MPU	1: Read.
				Serial Mode: Sserial data input.
E(CCL V*)	6		MPU	Parallel Mode: 1: Enable trigger.
E(SCLK*)	0	I	IMPU	Serial Mode: Serial clock.
D4 to D7	11 11	1/0	MDU	Higher nibble data bus of 8-bit interface
D4 to D7	11~14	I/O	MPU	and data bus for 4-bit interface
D0 to D3	7~10	I/O	MPU	Lower nibble data bus of 8-bit interface.
V_{DD}	2	I	Power	V _{DD} : 4.5V to 5.5V.
Vss	1	I	Power	VSS: 0V.
VOUT	18	0	Resistors	LCD voltage doubler output. VOUT ≦ 7V.

Function Description

System interface

ST7920 supports 3 kinds of bus interface to communicate with MPU: 8-bit parallel, 4-bit parallel and clock synchronized serial interface. Parallel interface is selected by PSB="1" and serial interface is by PSB="0". 8-bit / 4-bit interface is selected by function set instruction DL bit.

Two 8-bit registers (Data Register DR and Instruction Register IR) are used in ST7920 to access DRAM or Register. Data Register (DR) can access DDRAM, CGRAM and GDRAM through the address pointer implemented by Address Counter (AC). Instruction Register (IR) stores the instruction sent by MPU to ST7920.

4 kinds of parallel interface access mode can be selected through RS and RW:

RS	RW	Description
L	L	MPU write instruction to instruction register (IR)
L	Н	MPU read busy flag (BF) and address counter (AC)
Н	L	MPU write data to data register (DR)
Н	Н	MPU read data from data register (DR)

^{*} The serial interface access modes do not have Read operation.

Busy Flag (BF)

ST7920 needs a process time for any received instruction. Before finishing the received instruction, any further instruction is not accepted. The process time of each instruction is not equal and the internal process is finished or not can be determined by the BF. Internal operation is in progress while BF="1", that means ST7920 is in busy state. No further instructions will be accepted until BF="0". MPU must check BF to determine whether the internal operation is finished or not before issuing instruction.

Address Counter (AC)

Address Counter (AC) is used as the address pointer of DDRAM, CGRAM and GDRAM. (AC) can be set by instruction. After that, accesses (Read/Write operations) to the memories, such as DDRAM, CGRAM or GDRAM, (AC) will be increased or decreased by 1 (according to the setting in "Entry Mode Set" Register). When RS="0", RW="1" and E="1" the value of (AC) will be output to DB6~DB0.

Character Generation ROM (CGROM) and Half-width Character Generation ROM (HCGROM)

ST7920 is built in a Character Generation ROM (CGROM) to provide 8192 16x16 character fonts and a Half-width Character Generation ROM to provide 126 8x16 alphanumeric characters. It is easy to support multi-language applications such as Chinese and English. Two consecutive bytes are used to specify one 16x16 character or two 8x16 half-width characters. Character codes are written into DDRAM and the corresponding fonts are mapped from CGROM or HCGROM to the display drivers.

Character Generation RAM (CGRAM)

ST7920 is built in a Character Generation RAM (CGRAM) to support user-defined fonts. Four sets of 16x16 bit-maped RAM spaces are available. These user-defined fonts are displayed the same ways as CGROM fonts by writing the related character code into the DDRAM.

Display Data RAM (DDRAM)

There are 64x2 bytes RAM spaces for the Display Data RAM. It can store display data such as 16 characters (16x16) by 4 lines or 32 characters (8x16) by 4 lines. However, only 2 character-lines (maximum 32 common outputs) can be displayed at one time. Character codes stored in DDRAM will refer to the fonts specified by CGROM, HCGROM and CGRAM.

ST7920 can display half-width HCGROM fonts, user-defined CGRAM fonts and full 16x16 CGROM fonts. The character codes in 0000H~0006H will use user-defined fonts in CGRAM. The character codes in 02H~7FH will use half-width alpha numeric fonts. The character code larger than A1H will be treated as 16x16 fonts and will be combined with the next byte automatically. The 16x16 BIG5 fonts are stored in A140H~D75FH while the 16x16 GB fonts are stored in A1A0H~F7FFH. In short:

1. To display HCGROM fonts:

Write 2 bytes of data into DDRAM to display two 8x16 fonts. Each byte represents 1 character. The data is among 02H~7FH.

2. To display CGRAM fonts:

Write 2 bytes of data into DDRAM to display one 16x16 font.

Only 0000H, 0002H, 0004H and 0006H are acceptable.

3. To display CGROM fonts:

Write 2 bytes of data into DDRAM to display one 16x16 font.

A140H~D75FH are BIG5 code, A1A0H~F7FFH are GB code.

The higher byte (D15~D8) is written first and the lower byte (D7~D0) is the next.

Please refer to Table 5 for the relationship between DDRAM and the address/data of CGRAM.

CGRAM fonts and CGROM fonts can only be displayed in the start position of each address. (Refer to Table 4)

	80)	8		8	2	8	3	8	4	8	5	8	6	8	7	8	8	8	9	8	Α	8	В	8	С	8	D	8	Ε	8	F
Н		Г	Τ	L	Τ	L	Η	L	Τ	L	Н	L	Η	L	Н	L	Н	Н	Η	L	Н	L	Н	L	Η	L	Τ	Г	Τ	Г	Н	L
S		i	t	r	0	n	i	Х		S	T	7	9	2	0																	
	矽	•	ĺ	ij	冒	Ī	Ţ	7			Image: Control of the	þ	3		刹	Á	石	馬		(Ī	Ē.	矷	隺)							
	矽	,	ĺ	ij	訇	Ì	Π	ζ-				П	Þ	7.	文	糸	扁	矼	馬													

Table 4

Incorrect start position

Graphic RAM (GDRAM)

Graphic Display RAM has 64x256 bits bit-mapped memory space. GDRAM address is set by writing 2 consecutive bytes of vertical address and horizontal address. Two-byte data (16 bits) configures one GDRAM horizontal address. The Address Counter (AC) will be increased by one automatically after receiving the 16-bit data for the next operation. After the horizontal address reaching 0FH, the horizontal address will be set to 00H and the vertical address will not change. The procedure is summarized below:

- 1. Set vertical address (Y) for GDRAM
- 2. Set horizontal address (X) for GDRAM
- 3. Write D15~D8 to GDRAM (first byte)
- 4. Write D7~D0 to GDRAM (second byte)

Please refer to Table 7 for Graphic Display RAM mapping.

LCD driver

ST7920 embedded LCD driver has 33 commons and 64 segments to drive the LCD panel. Segment data from CGRAM, CGROM and HCGROM are shifted into the 64 bits segment latche to display. Extended segment driver (ST7921) can be used to extend the segment outputs upto 256 segments.



DDRAM data CGR (char. code) Add								M		(CG	R	Α	M	da	ata	3	(CG	R	Α	M	da	ata	a
(char. c	0	de)			Ac	ld	r.		(hi	gł	1e	r I	Эy	te)		(lc	W	eı	' b	y	te))
	В	В	В	В	В	В	В	В	В	D	D	D	D	D	D	D	D	D	D	D	D	D	D	D	D
B15~ B4	3	2	1	0	5	1 3	2	1	0	1	1	1	1	1	1	9	8	7	6	5	4	3	2	1	0
										5	4	3	2	1	0										
						0	0	0	0	0	0	0	0	0	1	0	0	0	1	1	0	0	0	0	0
						0	0	0	1	1	1	1	1	1	1	1	0	0	1	0	0	0	0	0	0
						0	0	1	0	0	0	0	1	0	0	0	0	0	1	0	0	0	1	0	0
						0	0	1	1	0	0	0	1	0	0	0	0	0	1	1	1	1	1	1	0
						0	1	0	0	0	0	1	0	0	1	0	0	1	0	0	0	0	1	0	0
						0	1	0	1	0	0	1	1	1	1	0	0	1	0	0	0	0	1	0	0
						0	1	1	0	0	1	1	0	0	1	0	1	0	1	0	0	1	0	0	0
0	X	٨	0	Х	00	0	1	1	1	1	0	1	0	0	1	1	0	0	1	0	0	1	0	0	0
	^	١	U	^	UC	1	0	0	0	0	0	1	0	0	1	0	0	0	1	0	1	0	0	0	0
						1	0	0	1	0	0	1	0	0	1	0	0	0	0	0	1	0	0	0	0
						1	0	1	0	0	0	1	0	0	1	0	0	0	0	1	0	0	0	0	0
						1	0	1	1	0	0	1	1	1	1	0	0	0	0	1	0	0	0	0	0
						1	1	0	0	0	0	1	0	0	1	0	0	0	1	0	0	0	0	0	0
						1	1	0	1	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
						1	1	1	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
						1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
						0	0	0	0	0	0	0	0	1	1	0	0	0	0	0	0	0	1	1	0
						0	0	0	1	0	0	0	1	1	0	1	0	0	0	0	0	0	1	0	0
						0	0	1	0	0	0	1	0	0	0	0	1	0	0	1	1	0	1	0	0
						0	0	1	1	0	1	0	1	1	1	0	1	1	0	1	0	0	1	0	0
						0	1	0	0	1	0	0	0	0	0	0	0	1	0	1	0	0	1	0	0
						0	1	0	1	0	1	1	1	1	1	1	1	0	0	1	0	0	1	0	0
						0	1	1	0	0	1	0	0	0	0	0	1	0	0	1	0	0	1	0	0
	X	_	1	~	01	0	1	1	1	0	1	1	1	1	1	1	1	0	0	1	0	0	1	0	0
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						1	0	0	1	0	1	1	1	1	1	1	1	0	0	1	0	0	1	0	0
						1	0	1	0	0	1	0	0	0	0	0	0	0	0	1	0	0	1	0	0
						1	0	1	1	0	1	1	1	1	1	1	1	1	0		0	0	1	0	0
						1	1	0	0	1	0	1	0	0	0	0	0	1	0	1	0	0	1	0	0
						1	1	0	1	1	0	1	1	1	1	1	1	1	0	0	1	1	1	0	0
						1	1	1	0	1	0	1	0	0	0	0	0	1	0	0	0	1	0	0	0
						1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Table 5: DDRAM data (character code) vs. CGRAM data/address map

Note:

- 1. DDRAM data (character code) bit1 and bit2 are identical with CGRAM address bit4 and bit5.
- 2. CGRAM address bit0 to bit3 specify total 16 rows. Row-16 is for cursor display. The data in Row-16 will be logically OR to the cursor.
- 3. CGRAM data for each address is 16 bits.
- 4. To select the CGRAM font, the bit4 through bit15 of DDRAM data must be "0" while bit0 and bit3 are "don't care".

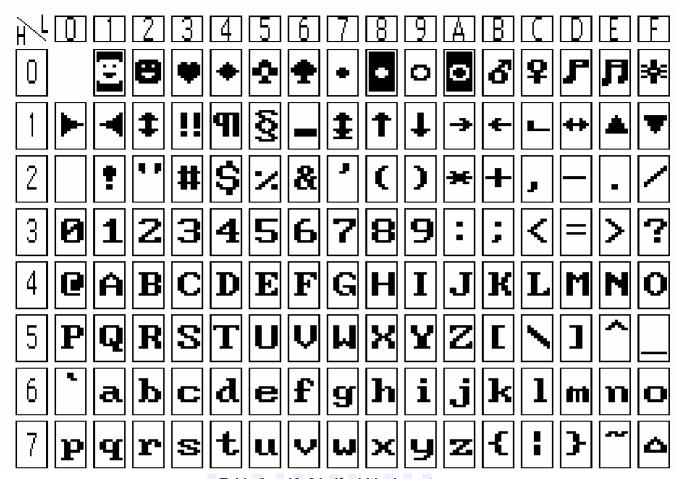


Table 6 16x8 half-width characters

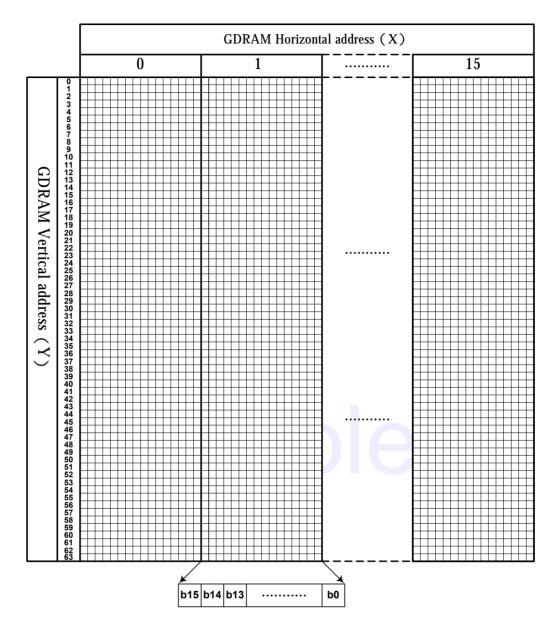


Table 7 GDRAM display coordinates and corresponding address

Instructions

ST7920 offers basic instruction set and extended instruction set:

Instruction Set 1: (RE=0: Basic Instruction)

Inot					Co	de					Description	Exec time
Inst.	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	(540KHZ)
Display Clear	0	0	0	0	0	0	0	0	0	1	Fill DDRAM with "20H" and set DDRAM address counter (AC) to "00H".	1.6 ms
Return Home	0	0	0	0	0	0	0	0	1	Х	Set DDRAM address counter (AC) to "00H", and put cursor to origin : the content of DDRAM are not changed	72 us
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	s	Set cursor position and display shift when doing write or read operation	72 us
Display Control	0	0	0	0	0	0	1	D	С	В	D=1: Display ON C=1: Cursor ON B=1: Character Blink ON	72 us
Cursor Display Control	0	0	0	0	0	1	S/C	R/L	x	x	Cursor position and display shift control; the content of DDRAM are not changed	72 us
Function Set	0	0	0	0	1	DL	Х	0 RE	х	х	DL=1 8-bit interface DL=0 4-bit interface RE=1: extended instruction RE=0: basic instruction	72 us
Set CGRAM Address.	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address to address counter (AC) Make sure that in extended instruction SR=0 (scroll or RAM address select)	72 us
Set DDRAM Address.	0	0	1	0 AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address to address counter (AC) AC6 is fixed to 0	72 us
Read Busy Flag (BF) & AC.	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Read busy flag (BF) for completion of internal operation, also Read out the value of address counter (AC)	0 us
Write RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data to internal RAM (DDRAM/CGRAM/GDRAM)	72 us
Read RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM/GDRAM)	72 us

Instruction set 2: (RE=1: extended instruction)

Inst.					Co	de					Description	Exec time
IIISt.	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	(540KHZ)
Standby	0	0	0	0	0	0	0	0	0	1	Enter standby mode, any other instruction can terminate. COM132 are halted.	72 us
Scroll or RAM Address. Select	0	0	0	0	0	0	0	0	1	SR	SR=1: enable vertical scroll position SR=0: enable CGRAM address (basic instruction)	72 us
Reverse (by line)	0	0	0	0	0	0	0	1	R1	R0	Select 1 out of 4 line (in DDRAM) and decide whether to reverse the display by toggling this instruction R1,R0 initial value is 0.0	72 us
Extended Function Set	0	0	0	0	1	DL	X	1 RE	G	0	DL=1 :8-bit interface DL=0 :4-bit interface RE=1: extended instruction set RE=0: basic instruction set G=1 :graphic display ON G=0 :graphic display OFF	72 us
Set Scroll Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	SR=1: AC5~AC0 the address of vertical scroll	72 us
Set Graphic Display RAM Address	0	0	1	0	0 AC5				AC1		Set GDRAM address to address counter (AC) Set the vertical address first and followed the horizontal address by consecutive writings Vertical address range: AC5AC0 Horizontal address range: AC3AC0	72 us

Note:

- 1. Make sure that ST7920 is not in busy state by reading the busy flag before sending instruction or data. If using delay loop instead, please make sure the delay time is enough. Please refer to the instruction execution time.
- 2. "RE" is the selection bit of basic and extended instruction set. After setting the RE bit, the value will be kept. So that the software doesn't have to set RE every time when using the same instruction set.

Initial Setting (Register flag) (RE=0: basic instruction)

Inot					Co	de					Deceription
Inst.	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description
Entry Mode	0	0	0	0	0	0	0	1	I/D	S	
Set									1	0	Cursor move to right ,DDRAM address counter (AC) plus 1
Display	0	0	0	0	0	0	1	D	С	В	Disalar, aurea and blink are ALL OFF
Control								0	0	0	Display, cursor and blink are ALL OFF
CURSOR	0	0	0	0	0	1	S/C	R/L	Х	Х	No. 10 to 10
DISPLAY SHIFT							х	х			No cursor or display shift operation
FUNCTION	0	0	0	0	1	DL	х	0 RE	х		8-bit MPU interface , basic instruction set
SET						1		0			O-Dit IVII O III. ETIACE, DASIC IIISII UCIIOTI SEL

Initial Setting (Register flag) (RE=1: extended instruction set)

Inot					Co	de					Description		
Inst.	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description		
SCROLL OR RAM	0	0	0	0	0	0	0	0	1	SR			
ADDR. SELECT										0	Allow vertical scroll or set CGRAM address		
DEVEDOE	0	0	0	0	0	0	0	1	R1	R0	Desir with respect and to make to severe		
REVERSE									0	0	Begin with normal and toggle to reverse		
EXTENDED FUNCTION	0	0	0	0	1	DL	Х	1 RE	G	0 Graphic display OFF			
SET									0		Glapfile display Of 1		

Description of basic instruction set

I Display Clear

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code	0	0	0	0	0	0	0	0	0	1

This instruction will change the following items:

- 1. Fill DDRAM with "20H"(space code).
- 2. Set DDRAM address counter (AC) to "00H".
- 3. Set Entry Mode I/D bit to be "1". Cursor moves right and AC adds 1 after write or read operation.
- I Return Home

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code	0	0	0	0	0	0	0	0	1	Х

Set address counter (AC) to "00H". Cursor moves to origin. Then content of DDRAM is not changed.

I Enry Mode Set

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code	0	0	0	0	0	0	0	1	I/D	S

Set the cursor movement and display shift direction when doing write or read operation.

I/D: Address Counter Control: (Increase/Decrease)

When I/D = "1", cursor moves right, address counter (AC) is increased by 1.

When I/D = "0", cursor moves left, address counter (AC) is decreased by 1.

S: Display Shift Control: (Shift Left/Right)

S	I/D	DESCRIPTION
Н	Н	Entire display shift left by 1
Н	L	Entire display shift right by 1

I Display Control

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code 0 0 0 0 0 0 1 D C B

Controls display, cursor and blink ON/OFF.

D: Display ON/OFF control bit

When D = "1", display ON

When D = "0", display OFF, the content of DDRAM is not changed

C: Cursor ON/OFF control bit

When C = "1", cursor ON.

When C = "0", cursor OFF.

B: Character Blink ON/OFF control bit

When B = "1", cursor position blink ON. Then display data (character) in cursor position will blink.

When B = "0", cursor position blink OFF

I Cursor/Display Shift Control

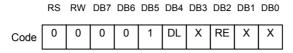
RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code	0	0	0	0	0	1	S/C	R/L	Х	Х

This instruction configures the cursor moving direction or the display shifting direction. The content of DDRAM is not changed.

S/C	R/L	Description	AC Value
L	L	Cursor moves left by 1 position	AC=AC-1
L	Н	Cursor moves right by 1 position	AC=AC+1
Н	L	Display shift left by 1, cursor also follows to shift.	AC=AC
Н	Н	Display shift right by 1, cursor also follows to shift.	AC=AC

I Function Set



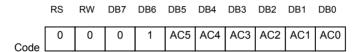
DL: 4/8-bit interface control bit

When DL = "1", 8-bit MPU bus interface When DL = "0", 4-bit MPU bus interface **RE: extended instruction set control bit**

When RE = "1", extended instruction set When RE = "0", basic instruction set

In same instruction cannot alter DL and RE at once. Make sure that change DL first then RE.

I Set CGRAM Address

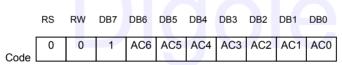


Set CGRAM address into address counter (AC)

AC range is 00H...3FH

Make sure that in extended instruction SR=0 (scroll address or RAM address select)

I Set DDRAM Address



Set DDRAM address into address counter (AC).

First line AC range is 80H...8FH

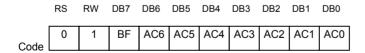
Second line AC range is 90H...9FH

Third line AC range is A0H...AFH

Fourth line AC range is B0H...BFH

Please note that only 2 lines can be display with one ST7920.

I Read Busy Flag (BF) and Address



Read busy flag (BF) can check whether the internal operation is finished or not. At the same time, the value of address counter (AC) is also read. When BF = "1", further instruction(s) will not be accepted until BF = "0".

Write Data to RAM

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code	1	0	D7	D6	D5	D4	D3	D2	D1	D0

Write data to the internal RAM and increase/decrease the (AC) by 1

Each RAM address (CGRAM, DDRAM and GDRAM...) must write 2 consecutive bytes for 16-bit data. After receiving the second byte, the address counter will increase or decrease by 1 according to the entry mode set control bit.

I Read RAM Data

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code	1	1	D7	D6	D5	D4	D3	D2	D1	D0

Read data from the internal RAM and increase/decrease the (AC) by 1

After the operation mode changed to Read (CGRAM, DDRAM and GDRAM...), a "Dummy Read" is required. There is no need to add a "Dummy Read" for the following bytes unless a new address set instruction is issued.



Description of extended instruction set

I Standby

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code 0 0 0 0 0 0 0 0 1

This Instruction will set ST7920 entering the standby mode. Any other instruction follows this instruction will terminate the standby mode.

The content of DDRAM remains the same.

Vertical Scroll or RAM Address Select

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code	0	0	0	0	0	0	0	0	1	SR
------	---	---	---	---	---	---	---	---	---	----

When SR = "1", the Vertical Scroll mode is enabled.

When SR = "0", "Set CGRAM Address" instruction (basic instruction) is enabled.

I Reverse

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code	0	0	0	0	0	0	0	1	R1	R0

Select 1 out of 4 lines to reverse the display and to toggle the reverse condition by repeating this instruction. R1, R0 initial vale is 00. The first time issuing this instruction, the display will be reversed while the second time will return the display become normal.

R1	R0	Description
L	L	First line normal or reverse
L	Н	Second line normal or reverse
Н	L	Third line normal or reverse
Н	Н	Fourth line normal or reverse

Please note that only 2 lines out of 4 lines of display data can be displayed with one ST7920.

I Extended Function Set

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Code 0 0 0 0 1 DL X RE G X

DL: 4/8-bit interface control bit

When DL = "1", 8-bit MPU interface. When DL = "0", 4-bit MPU interface.

RE: extended instruction set control bit

When RE = "1", extended instruction set

When RE = "0", basic instruction set

G: Graphic display control bit

When G = "1", Graphic Display ON

When G = "0", Graphic Display OFF

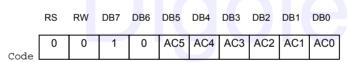
In same instruction cannot alter DL, RE and G at once. Make sure that change DL or G first and then RE.

I Set Scroll Address

	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0

SR=1: AC5~AC0 is vertical scroll displacement address

I Set Graphic RAM Address



	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	0	1	0	0	0	AC3	AC2	AC1	AC0

Set GDRAM address into address counter (AC). This is a 2-byte instruction.

The first instruction sets the vertical address while the second one sets the horizontal address (write 2 consecutive bytes to complete the vertical and horizontal address setting).

Vertical address range is AC5...AC0

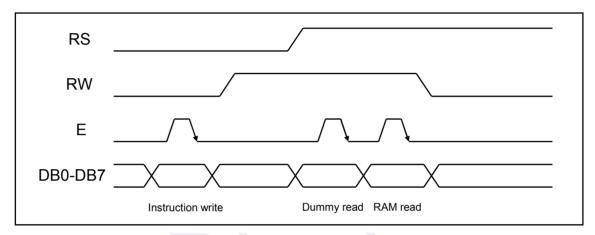
Horizontal address range is AC3...AC0

The address counter (AC) of graphic RAM (GRAM) will be increased automatically after the vertical and horizontal addresses are set. After horizontal address is increased upto 0FH, it will automatically return to 00H. However, the vertical address will not increase as the result of the same action.

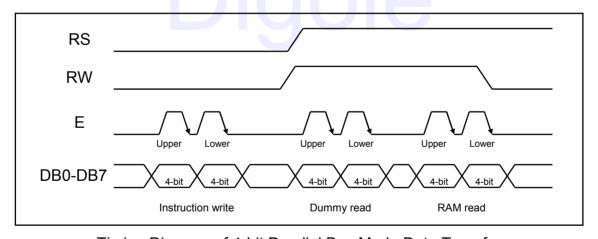
Parallel interface:

ST7920 is in parallel mode by pulling up PSB pin. ST7920 can select 8-bit or 4-bit bus interface by setting the DL control bit in "Function Set" instruction. MPU can control RS, RW, E and DB0...DB7 pins to complete the data transmission.

In 4-bit transfer mode, every 8-bit data or instruction is separated into 2 parts. The higher 4 bits (bit-7~bit-4) data will be transfered first through data pins (DB7~DB4). The lower 4 bits (bit-3~bit-0) data will be transfered second through data pins (DB7~DB4). The (DB3~DB0) data pins are not used during 4-bit transfer mode.



Timing Diagram of 8-bit Parallel Bus Mode Data Transfer



Timing Diagram of 4-bit Parallel Bus Mode Data Transfer

Serial interface:

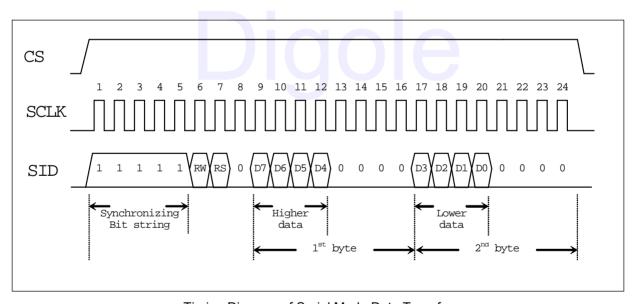
ST7920 is in serial interface mode when pulling down PSB pin. Two pins (SCLK and SID) are used to complete the data transfer. Only write data is available in the serial interface mode.

When chip select (CS) is low, ST7920 serial clock counter and serial data will be reset. Serial transfer counter is set to the first bit and data register is cleared. After CS is "L", any further change on SID or SCLK is not allowed. It is recommended to keep SCLK at "L" and SID at the last status before set CS to "L". For a minimal system with only one ST7920 and one MPU, only SCLK and SID pins are necessary. CS pin should pull to high.

ST7920's serial clock (SCLK) is asynchronous to the internal clock and is generated by MPU. When multiple instruction/data is transferred, the instruction execution time must be considered. MPU must wait till the previous instruction is finished and then send the next instruction. ST7920 has no internal instruction buffer area.

When starting a transmission, a start byte is required. It consists of 5 consecutive "1" (sync character). Serial transfer counter will be reset and synchronized. Followed by 2-bit flag that indicates: read/write (RW) and register/data selected (RS) operation. Last 4 bits are filled by "0".

After receiving the sync character, RW and RS bits, every 8 bits instruction/data will be separated into 2 groups. Higher 4 bits (DB7~DB4) will be placed in the first section followed by 4 "0"s. And lower 4 bits (DB3~DB0) will be placed in the second section followed by 4 "0"s.



Timing Diagram of Serial Mode Data Transfer

8051 demo program for serial interface

;; Write data from	A into INS	TRUCTION Register
; WRINS:		
SETB	CS	
SETB	SID	; SID = 1
CLR	SCLK	
SETB		; READ DATA FROM SID
CLR	SCLK	
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	DEAD DATA EDOM OID
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	DEAD DATA EDOM OID
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	, DEAD DATA EDOM OID
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	· CID = 0
CLR	SID	; SID = 0
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	, DEAD DATA EDOM CID
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	· DEAD DATA EDOM SID
SETB		; READ DATA FROM SID
CLR	SCLK	· SID = A 7
MOVBIT		; SID = A.7
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	. CID = A C
MOVBIT		; SID = A.6
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	. CID = A.F.
MOVBIT		; SID = A.5
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	. CID = A A
MOVBIT		; SID = A.4
SETB		; READ DATA FROM SID
CLR	SCLK	. 010 = 0
CLR	SID	; SID = 0
SETB		; READ DATA FROM SID
CLR	SCLK	, DEAD DATA EDOM CID
SETB	SCLK	; READ DATA FROM SID
CLR SETB	SCLK	- DEAD DATA FROM CID
	SCLK	; READ DATA FROM SID
CLR SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	, READ DATA FROM SID
MOVBIT		; SID = A.3
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	, NEAD DATAT NOW OID
MOVBIT		; SID = A.2
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	, ILL IS SITTI TOWN ON
MOVBIT		; SID = A.1
SETB	SCLK	
CLR	SCLK	, NEW DATA I NOW OID
		; SID = A.0
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	, ILL IS SITTI TOWN ON
CLR	SID	; SID = 0
SETB	SCLK	; READ DATA FROM SID
CLR	SCLK	, ILL IS DITITION OF
SETB	SCLK	: READ DATA FROM SID
CLR	SCLK	, NEAD DATAT NOW OID
SETB	SCLK	: READ DATA FROM SID
CLR	SCLK	, NEW DATA I NOW OID
SETB	SCLK	: READ DATA FROM SID
CLR	SCLK	, NEAD DATA I NOW SID
CLR	CS	
CALL	DLY8	
RET	DLIU	
INL I		

; Write data from	A into DAT	A Register
WRDATA:		
SETB SETB	CS	: SID = 1
CLR	SID SCLK	, 310 - 1
SETB	SCLK	; READ DATA FROM SID
CLR SETB	SCLK SCLK	; READ DATA FROM SID
CLR SETB	SCLK SCLK	; READ DATA FROM SID
CLR	SCLK	, NEAD DATAT NOW OID
SETB CLR	SCLK SCLK	; READ DATA FROM SID
SETB	SCLK	; READ DATA FROM SID
CLR CLR	SCLK SID	; SID = 0
SETB	SCLK	; READ DATA FROM SID
CLR SETB	SCLK SID	; SID = 1
SETB	SCLK	; READ DATA FROM SID
CLR CLR	SCLK SID	; SID = 0
SETB	SCLK	; READ DATA FROM SID
CLR MOVBIT	SCLK	: SID = A.7
SETB	SID, A.7 SCLK	; READ DATA FROM SID
CLR MOVBIT	SCLK SID, A.6	; SID = A.6
SETB	SCLK	; READ DATA FROM SID
CLR MOVBIT	SCLK	; SID = A.5
SETB	SID, A.5 SCLK	; READ DATA FROM SID
CLR	SCLK	. CID - A 4
MOVBIT SETB	SID, A.4 SCLK	; SID = A.4 ; READ DATA FROM SID
CLR	SCLK	. 010 - 0
CLR SETB	SID SCLK	; SID = 0 ; READ DATA FROM SID
CLR	SCLK	DEAD DATA EDOM OID
SETB CLR	SCLK SCLK	; READ DATA FROM SID
SETB CLR	SCLK SCLK	; READ DATA FROM SID
SETB	SCLK	; READ DATA FROM SID
CLR MOVBIT	SCLK SID, A.3	; SID = A.3
SETB CLR	SCLK SCLK	; READ DATA FROM SID
MOVBIT	SID, A.2	; SID = A.2
SETB CLR	SCLK SCLK	; READ DATA FROM SID
MOVBIT	SID, A.1	; SID = A.1
SETB CLR	SCLK SCLK	; READ DATA FROM SID
MOVBIT	SID, A.0	; SID = A.0
SETB CLR	SCLK SCLK	; READ DATA FROM SID
CLR SETB	SID SCLK	; SID = 0 ; READ DATA FROM SID
CLR SETB	SCLK SCLK	: READ DATA FROM SID
CLR	SCLK	,
SETB CLR	SCLK SCLK	; READ DATA FROM SID
SETB CLR	SCLK SCLK	; READ DATA FROM SID
CLR	CS	
CALL RET	DLY8	

Application circuit for testing CGROM and HCGROM:

We can use the function of "CHECK SUM" to check the CGROM is right or error.

See the following notes: Useing IC Pad (Pin4àCLK, Pin5àTT1, Pin6àTT2) to do the "CHECK SUM" function. The application circuit is at Page49.

Timing Diagram for checking CGROM (TT1=0, TT2=1)

The ST7920 check sum process: (DDRAM must be cleared by 0x00 before this process)

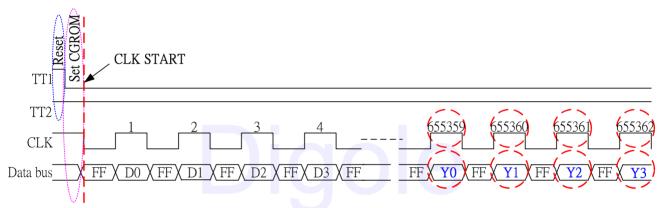
In the first place: Resetting the internal counter (set TT1 and TT2 to Height)

In the second place: Setting CGROM mode (set TT1 to Low, TT2 to Height).

In the third place: CLK starts to count 655362 times.

In the final place: Finishing the counting, read the last four bytes to CHECK SUM (reading only when the CLK is Height).

ST7920 check sum circuit: Data is available when CLK is height; if CLK is low then the data is always FFH. The last four bytes are Y0, Y1, Y2, and Y3.



The fatest execution time is: tCYC=1us (1MHz at 5V).

The table below is a comparing table of CGROM for different versions.

	Version	CGROM Last four bytes				
	(Font)	Y0	Y1	Y2	Y3	
1	Big5 (0A)	38	88	CC	F1	
2	GB (0B)	9D	81	79	29	
3	0C	FD	6F	B5	85	

Timing Diagram for checking HCGROM (TT1=1, TT2=0)

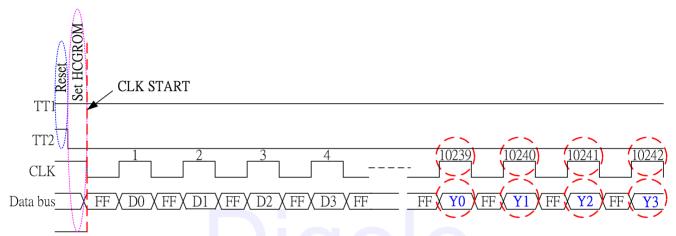
The ST7920 check sum process: (DDRAM must be cleared by 0x00 before this process)

In the first place: Resetting the internal counter (set TT1 and TT2 to Height) In the second place: Setting CGROM mode (set TT1 to Height, TT2 to Low).

In the third place: CLK starts to count 10242 times.

In the final place: Finishing the counting, read the last four bytes to CHECK SUM (reading only when the CLK is Height).

ST7920 check sum circuit: Data is available when CLK is height; if CLK is low then the data is always FFH. The last four bytes are Y0, Y1, Y2, and Y3.



The fatest execution time is: tCYC=2us (0.5MHz at 5V).

The table below is a comparing table of HCGROM for different versions.

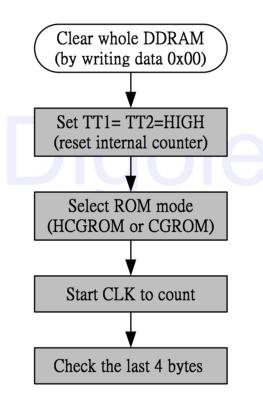
	Version	HCGROM last four bytes				
	(Font)	Y0	Y1	Y2	Y3	
1	Big5 (0A)	B5	11	B5	11	
2	GB (0B)	B5	11	B5	11	
3	0C	B5	11	B5	11	

Testing Step:

- 1. Clear whole DDRAM area by writing data 0x00.
- 2. Composing TT1 and TT2 to make the 'Reset' action, and clear the internal counter.
- 3. Selecting the test mode by setting TT1 and TT2 (CGROM or HCGROM).
- 4. After setp1 and setp2, entering some impulse signals through Pin4 (CLK).
- 5. Reading the CHECK SUM data through D0 to D7.
- 6. Comparing CHECK SUM with the Code Table (upper table) to check if the data is correct or not.

TT1	TT2	No. of counts	Status
1	1		RESET
0	1	655362	CGROM
1	0	10242	HGROM

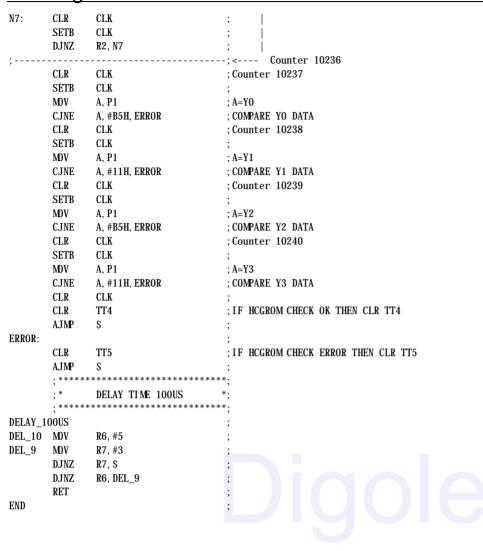
Test process flow:



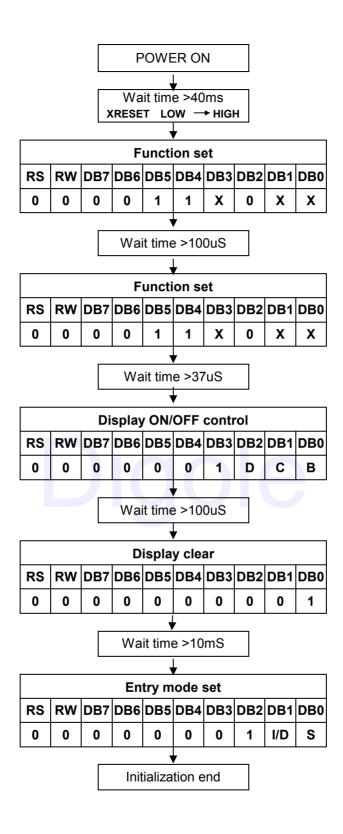
8051 CGROM · HCGROM illustrative test program

	. *****	********	,
	;*	CHECK_ROM *	,
	,	*********	,
	,	*********	,
	,	finition of outside	,
a	,		;
CLK	REG	P3. 5	;
TT1	REG	P3. 0	;
TT2	REG	P3. 1	;
TT3	REG		; CHECK CGROM FLAG
TT4	REG		; CHECK HCGROM FLAG
TT5	REG		; ERROR FLAG
	,	********	,
		inition of internal RAM * ********	
CTL CY	, *****		;
STACK		EQU 6FH	;
FUNC	ale ale ale ale ale ale	EQU 20H	;
	,	**************************************	,
	,	Interrupt set ***********	,
	,		•
	ORG	00H	• •
	AJMP	RESET **********	,
	, *		,
	. *****	PROGRAM START * ***********************************	,
RESET:	,		,
RESEI.	MOV MOV	SP, #STACK	,
	MDV	P1, #FFH	,
		P3, #FFH **********	<u>'</u>
	,	CHECK_CGROM *	
	, .*****	***********************	
	, .****	********	
	, .*	Initial DDRAM *	
	. *****	********	,
	CALL	WR0x00	;Write OxOO to whole DDRAM
	. *****	********	
	,*	Initial setting *	· ,
		********	· ,
CGROM	SETB	TT1	,
	SETB	TT2	; TT1, TT2 SET HIGH (RESET)
	CALL	DELAY_100US	; Wait Reset 100us
	CLR	TT1	; TT1=LOW TT2=HIGH (CHECK CGROM)
	SETB	CLK	;
	CALL	DELAY_100US	•
	.*****	********	;
	;*	start counter *	
	.*****	********	;
	MOV	R3, #9	;
CN4:	MOV	R2, #0	;<
CN3:	MOV	R1, #0	;
CN2:	CLR	CLK	;
	SETB	CLK	;
	DJNZ	R1, CN2	;
	DJNZ	R2, CN3	;
	DJNZ	R3, CN4	;
	MOV	DO #0	;
an-	MOV	R3, #0	;
CN5:	MOV	R2, #255	;
CN6:	CLR	CLK	;
	SETB	CLK	;
	DJNZ	R2, CN6	;
	DJNZ	R3, CN5	;
			;

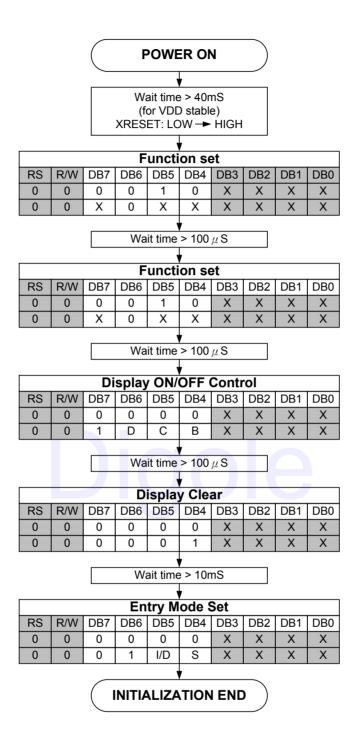
```
MOV
                R3, #63
               R2, #2
CN7:
       MOV
CN8:
       MOV
               R1. #2
CN9:
        CLR
               CLK
       SETB
               CLK
       DJNZ
               R1, CN9
        DJNZ
               R2. CN8
        DJNZ
               R3, CN7
       CLR
               CLK
       SETB
               CLK
        CLR
               CLK
        SETB
               CLK
                                       ; <---- Counter 655356
        :----
        CLR
               CLK
                                       ; Counter 655357
        SETB
               CLK
       MOV
                                       ; A=Y0
               A, P1
               A, #FDH, ERRORC
                                       ; COMPARE YO DATA
       CJNE
                                       :Counter 655358
        CLR
               CLK
        SETB
               CLK
       MOV
               A, P1
                                       ; A=Y1
                                       ; COMPARE Y1 DATA
        CJNE
               A, #6FH, ERRORC
        CLR
               CLK
                                       ; Counter 655359
       SETB
               CLK
       MOV
               A, P1
                                       ; A=Y2
        CJNE
               A, #B5H, ERRORC
                                       ; COMPARE Y2 DATA
        CLR
               CLK
                                       ; Counter 655360
       SETB
               CLK
        MOV
               A, P1
                                       ; A=Y3
        CJNE
               A, #85H, ERRORC
                                       ; COMPARE Y3 DATA
       CLR
               CLK
       CLR
               TT3
                                       ; IF OK CLR TT3
        CALL
               HCGROM
ERRORC:
                                       ; IF CGROM CHECK ERROR CLR TT5
       CLR
               CHECK_HCGROM
        .***********
               Initial setting
HCGROM SETB
               TT1
        SETB
               TT2
                                       ; TT1, TT2 SET HIGH (RESET)
               DELAY_100US
        CALL
                                       ; Wait Reset 100us
                                       ; TT2=LOW TT1=HIGH ( CHECK HCGROM)
        CLR
               TT2
       SETB
               CLK
        CALL
               DELAY_100US
               *******
               start counter
        MOV
               R3, #9
               R2, #32
N4:
        MOV
               R1, #32
N3:
        MOV
N2:
        CLR
               CLK
        SETB
               CLK
        DJNZ
               R1, N2
        DJNZ
               R2, N3
        DJNZ
               R3, N4
        MOV
               R3, #32
N5:
        MOV
               R2, #31
N6:
        CLR
               CLK
       SETB
               CLK
        DJNZ
               R2, N6
        DJNZ
               R3, N5
        MOV
                R2, #30
```



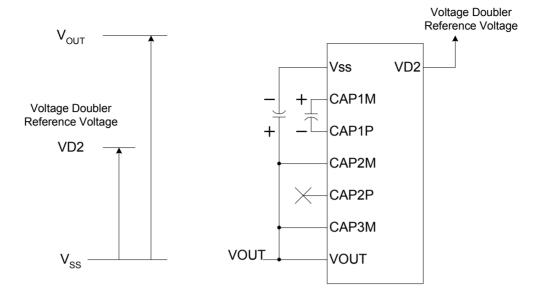
8-bit interface:



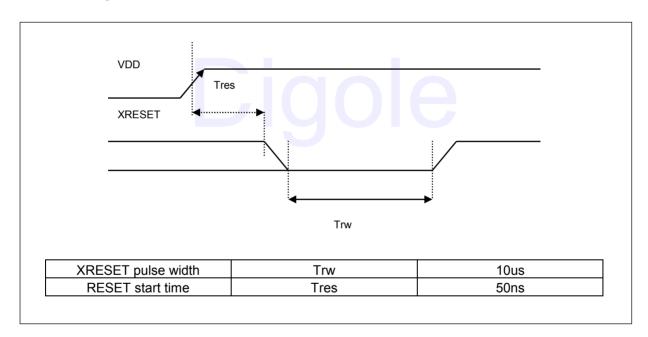
4-bit interface:



Built in voltage booster

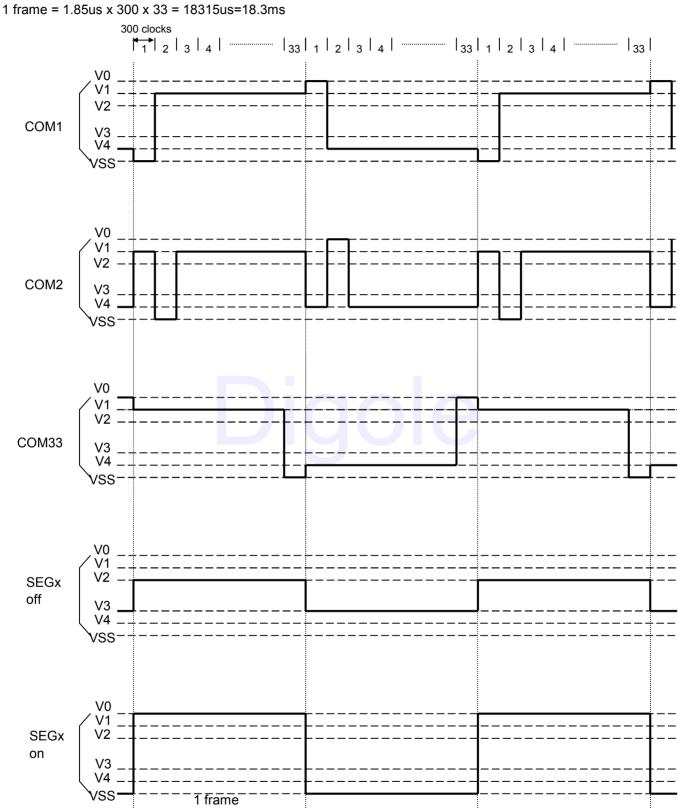


External reset timing



LCD driving wave form (1/33 duty, 1/5 bias)

When oscillation frequency is 540KHZ, 1 clock cycle time = 1.85us



Absolute Maximum Ratings

Characteristics	Symbol	Value
Power Supply Voltage	V_{DD}	-0.3V to +6.0V
LCD Driver Voltage	V _{LCD} or V0	-0.3V to +7.0V
Voltage Doubler Output	V_{OUT}	-0.3V to +7.0V
Input Voltage	V_{IN}	-0.3V to V_{DD} +0.3V
Operating Temperature	T _A	-30°C to +85°C
Storage Temperature	T _{STO}	-65°C to +150°C

DC Characteristics (T_A = -30 $^{\circ}$ C ~ 85 $^{\circ}$ C, V_{DD} = 2.7 V - 4.5 V)

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
V_{DD}	Operating Voltage	-	2.7	1	5.5	V
V_{LCD}	LCD Voltage	V0-VSS	3.0	ı	7	V
I _{CC}	Power Supply Current	f_{OSC} = 530KHz, V_{DD} =3.0V Rf=18K Ω	-	0.20	0.45	mA
V_{IH1}	Input High Voltage (Except OSC1)	-	0.7V _{DD}	-	V_{DD}	V
V _{IL1}	Input Low Voltage (Except OSC1)	-	- 0.3	-	0.6	V
V _{IH2}	Input High Voltage (OSC1)	-	V _{DD} – 1	-	V _{DD}	V
V_{IL2}	Input Low Voltage (OSC1)		_	-	1.0	V
V_{OH1}	Output High Voltage (DB0 - DB7)	I _{OH} = -0.1mA	0.8V _{DD}	-	V_{DD}	V
V _{OL1}	Output Low Voltage (DB0 - DB7)	I _{OL} = 0.1mA	-	-	0.1	V
V_{OH2}	Output High Voltage (Except DB0 - DB7)	I _{OH} = -0.04mA	0.8V _{DD}	-	V_{DD}	V
V _{OL2}	Output Low Voltage (Except DB0 - DB7)	I _{OL} = 0.04mA	-	ı	0.1V _{DD}	V
I _{LEAK}	Input Leakage Current	V_{IN} = 0V to V_{DD}	-1	-	1	μΑ
I _{PUP}	Pull Up MOS Current	$V_{DD} = 3V$	22	27	32	μΑ

DC Characteristics (T_A = -30 $^{\circ}$ C ~ 85 $^{\circ}$ C, V_{DD} = 4.5 V - 5.5 V)

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
V_{DD}	Operating Voltage	-	4.5	-	5.5	V
V_{LCD}	LCD Voltage	V0-V _{SS}	3.0	ı	7	V
I _{cc}	Power Supply Current	f_{OSC} = 540KHz, V_{DD} =5V Rf=33K Ω	-	0.45	0.75	mA
V _{IH1}	Input High Voltage (Except OSC1)	-	0.7V _{DD}	1	V_{DD}	V
V _{IL1}	Input Low Voltage (Except OSC1)	-	-0.3	-	0.6	V
V_{IH2}	Input High Voltage (OSC1)	-	V _{DD} -1	1	V_{DD}	V
V _{IL2}	Input Low Voltage (OSC1)	-	1	-	1.0	٧
V _{OH1}	Output High Voltage (DB0 - DB7)	I _{OH} = -0.1mA	0.8V _{DD}	1	V_{DD}	V
V _{OL1}	Output Low Voltage (DB0 - DB7)	I _{OL} = 0.1mA	-	ı	0.4	V
V _{OH2}	Output High Voltage (Except DB0 - DB7)	I _{OH} = -0.04mA	0.8V _{DD}	1	V _D D	V
V _{OL2}	Output Low Voltage (Except DB0 - DB7)	I _{OL} = 0.04mA	-	1	0.1V _{DD}	V
I _{LEAK}	Input Leakage Current	V_{IN} = 0V to V_{DD}	-1	-	1	μΑ
I _{PUP}	Pull Up MOS Current	$V_{DD} = 5V$	75	80	85	μΑ

AC Characteristics (T_A = -30 $^{\circ}$ C ~ 85 $^{\circ}$ C, V_{DD} = 4.5V) Parallel Mode Interface

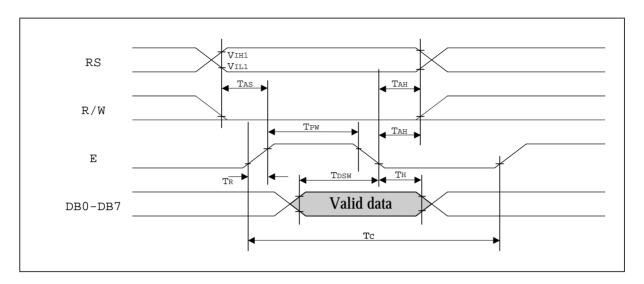
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit			
		Internal Clock Operation	1						
f _{OSC}	OSC Frequency	$R = 33K\Omega$	480	540	600	KHz			
	External Clock Operation								
f_{EX}	External Frequency	1	480	540	600	KHz			
	Duty Cycle	1	45	50	55	%			
T_R, T_F	Rise/Fall Time	-	-	-	0.2	μS			
	Write Mod	le (Writing data from MPU	to ST79	920)					
T _C	Enable Cycle Time	Pin E	1200	-	-	ns			
T_PW	Enable Pulse Width	Pin E	140	-	-	ns			
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns			
T_{AS}	Address Setup Time	Pins: RS,RW,E	10	-	-	ns			
T_{AH}	Address Hold Time	Pins: RS,RW,E	20	-	-	ns			
T_{DSW}	Data Setup Time	Pins: DB0 - DB7	40	-	-	ns			
T _H	Data Hold Time	Pins: DB0 - DB7	20	-	-	ns			
	Read Mode	e (Reading Data from ST7	7920 to N	1PU)					
T _C	Enable Cycle Time	Pin E	1200	-	-	ns			
T_PW	Enable Pulse Width	Pin E	140	-	-	ns			
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns			
T_{AS}	Address Setup Time	Pins: RS,RW,E	10	-	-	ns			
T_AH	Address Hold Time	Pins: RS,RW,E	20	-	-	ns			
T_{DDR}	Data Delay Time	Pins: DB0 - DB7	-	-	100	ns			
T _H	Data Hold Time	Pins: DB0 - DB7	20	-	-	ns			
	Interfac	ce Mode with LCD Driver(ST7921,)					
T _{CWH}	Clock Pulse with High	Pins: CL1, CL2	800	-	-	ns			
T_{CWL}	Clock Pulse with Low	Pins: CL1, CL2	800	-	-	ns			
T _{CST}	Clock Setup Time	Pins: CL1, CL2	500	-	-	ns			
T_{SU}	Data Setup Time	Pin: D	300	-	-	ns			
T_DH	Data Hold Time	Pin: D	300	-	-	ns			
T_DM	M Delay Time	Pin: M	-1000	-	1000	ns			

AC Characteristics (T_A = -30 $^{\circ}$ C ~ 85 $^{\circ}$ C, V_{DD} = 2.7V) Parallel Mode Interface

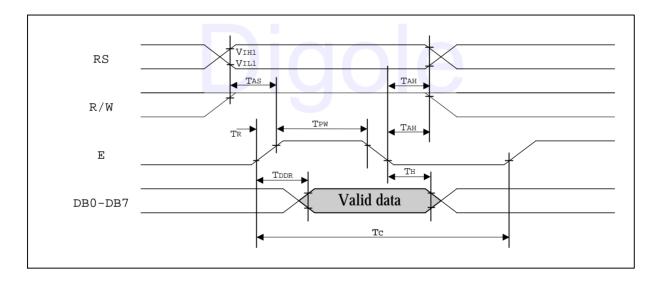
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit			
		Internal Clock Operation)						
f _{osc}	OSC Frequency	R = 18KΩ	470	530	590	KHz			
	External Clock Operation								
f_{EX}	External Frequency	-	470	530	590	KHz			
	Duty Cycle	-	45	50	55	%			
T_R, T_F	Rise/Fall Time	-	-	-	0.2	μS			
	Write Mod	le (Writing data from MPU	to ST79	920)					
T _C	Enable Cycle Time	Pin E	1800	-	-	ns			
T_PW	Enable Pulse Width	Pin E	160	-	-	ns			
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns			
T _{AS}	Address Setup Time	Pins: RS,RW,E	10	-	-	ns			
T_AH	Address Hold Time	Pins: RS,RW,E	20	-	-	ns			
T_{DSW}	Data Setup Time	Pins: DB0 - DB7	40	-	-	ns			
T _H	Data Hold Time	Pins: DB0 - DB7	20	-	-	ns			
	Read Mode	e (Reading Data from ST7	7920 to N	1PU)					
Tc	Enable Cycle Time	Pin E	1800	-	-	ns			
T_PW	Enable Pulse Width	Pin E	320	-	-	ns			
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns			
T_{AS}	Address Setup Time	Pins: RS,RW,E	10	-	-	ns			
T_{AH}	Address Hold Time	Pins: RS,RW,E	20	-	-	ns			
T_{DDR}	Data Delay Time	Pins: DB0 - DB7	-	-	260	ns			
T _H	Data Hold Time	Pins: DB0 - DB7	20	-	-	ns			
	Interfac	ce Mode with LCD Driver(ST7921,		,				
T _{CWH}	Clock Pulse with High	Pins: CL1, CL2	800	-	-	ns			
T_{CWL}	Clock Pulse with Low	Pins: CL1, CL2	800	-	-	ns			
T _{CST}	Clock Setup Time	Pins: CL1, CL2	500	-	-	ns			
T_{SU}	Data Setup Time	Pin: D	300	-	-	ns			
T_DH	Data Hold Time	Pin: D	300	-	-	ns			
T_DM	M Delay Time	Pin: M	-1000	-	1000	ns			

8-bit interface timing diagram

I MPU write data to ST7920



I MPU read data from ST7920



AC Characteristics (T_A = -30 $^{\circ}$ C ~ 85 $^{\circ}$ C, V_{DD} = 4.5V) Serial Mode Interface

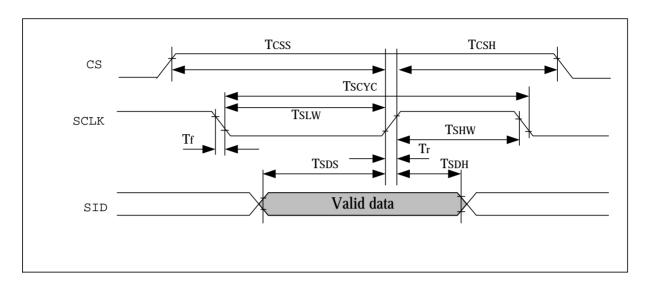
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit		
	Internal Clock Operation							
f _{OSC}	OSC Frequency	R = 33KΩ	470	530	590	KHz		
		External Clock Operation	1					
f_{EX}	External Frequency	-	470	530	590	KHz		
	Duty Cycle	-	45	50	55	%		
T_R, T_F	Rise/Fall Time	-	-	-	0.2	μS		
T _{SCYC}	Serial clock cycle	Pin E	400	-	-	ns		
T_{SHW}	SCLK high pulse width	Pin E	200	-	-	ns		
T_{SLW}	SCLK low pulse width	Pin E	200	-	-	ns		
T_{SDS}	SID data setup time	Pins RW	40	-	-	ns		
T_{SDH}	SID data hold time	Pins RW	40	-	-	ns		
T _{CSS}	CS setup time	Pins RS	60	-	_	ns		
T_{CSH}	CS hold time	Pins RS	60	-	-	ns		

AC Characteristics ($T_A = -30^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{DD} = 2.7V$) Serial Mode Interface

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit			
	Internal Clock Operation								
f _{OSC}	OSC Frequency	R = 18KΩ	470	530	590	KHz			
		External Clock Operation	7						
f _{EX}	External Frequency		470	530	590	KHz			
	Duty Cycle	-	45	50	55	%			
T_R, T_F	Rise/Fall Time	-	-	-	0.2	μS			
T _{SCYC}	Serial clock cycle	Pin E	600	-	-	ns			
T _{SHW}	SCLK high pulse width	Pin E	300	-	-	ns			
T_{SLW}	SCLK low pulse width	Pin E	300	-	-	ns			
T_{SDS}	SID data setup time	Pins RW	40	-	-	ns			
T_{SDH}	SID data hold time	Pins RW	40	-	-	ns			
T _{CSS}	CS setup time	Pins RS	60	-	_	ns			
T _{CSH}	CS hold time	Pins RS	60	-	-	ns			

Serial interface timing diagram

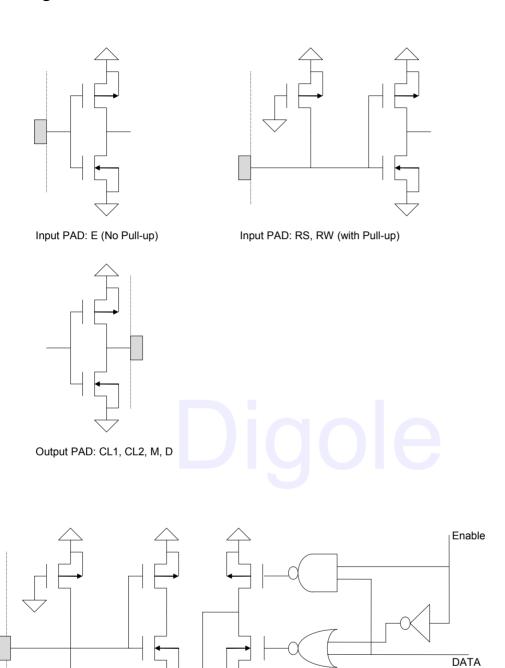
I MPU write data to ST7920

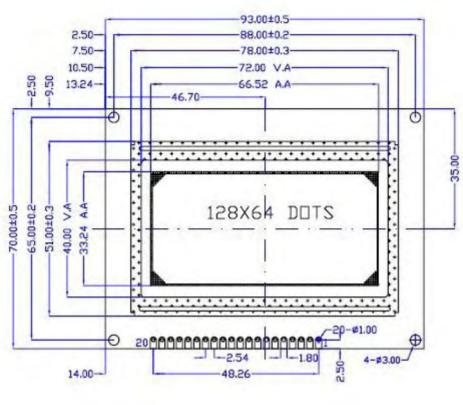




I/O pin diagram

I/O PAD: DB0 – DB7





Digole